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[home](#) [page](#) [about us](#) [contact](#)

[us](#)

**Table of
Contents**

IN PRESS

JFS 2015

JFS 2014

JFS 2013

JFS 2012

JFS 2011

JFS 2010

JFS 2009

JFS 2008

JFS 2007

JFS 2006

JFS 2005

JFS 2003

JFS Home

**Editorial
Board**

For Authors

- **Authors
Declaration**
- **Instruction
to Authors**
- **Guide for
Authors**
- **Copyright
Statement**
- **Submission**

**For
Reviewers**

- **Guide for
Reviewers**
 - **Reviewers
Login**
-

Subscription

Journal of Forest Science

**The influence of particle composition in a three-layer particleboard
on its physical and mechanical properties**

[[fulltext](#)]

The paper deals with results of research aimed at the problem of the maximum possible amount of added sawdust to standard particles into surface and central layers of three-layer particleboards in order that the physical and mechanical properties of particleboards will comply with the CSN 49 2614 Standard. Waste from wood processing is widely used for the production of particleboards. For that purpose, three-layer particleboards with computed density of 740 kg/m³ at seven versions A-G with 0–30% sawdust addition to standard particles were manufactured in a laboratory. Five particleboards 500 × 500 × 16 mm were made for each version. These air-conditioned particleboards were cut into specimens in which physical and mechanical properties such as moisture, density, swelling, perpendicular tensile strength and bending strength were determined. It is obvious from the results of physical and mechanical properties that during the production of particleboards sawdust at a quantity of max. 25% can be added to standard particles when all values of physical and mechanical properties are in accordance with the CSN 49 2614 Standard.

Keywords:

particleboard; physical and mechanical properties; density; moisture; bending strength; tensile strength; swelling; statistical analysis; sawdust

[[fulltext](#)]